

FCZ120N40M2

N沟道eSiC碳化硅功率MOSFET

1200 V, 57 A, 40 mΩ



Features

- 高开关频率，低栅极电荷
- 具有低反向恢复的快速体二极管
- 强大的雪崩能力
- 100% 雪崩测试
- 无铅、无卤且符合RoHS标准

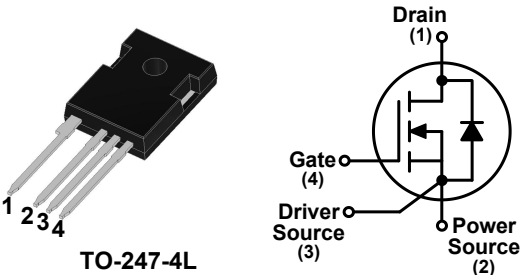
$BV_{DSS}, T_c=25^{\circ}C$	$I_D, T_c=25^{\circ}C$	$R_{DS(on),typ}$	$Q_{g,typ}$
1200 V	57 A	40 mΩ	62 nC

Benefits

- 提供效率提升
- 更高频率的适用性
- 增强功率密度
- 减少冷却工作量

Applications

- 光伏逆变器
- 新能源汽车充电桩
- UPS
- 工业电源



绝对最大额定值 ($T_C = 25^{\circ}C$ ，除非另有说明)

Symbol	Parameter		Value	Unit
V_{DSS}	Drain to Source Voltage		1200	V
V_{GS}	Gate to Source Voltage (DC)		-10 / +22	V
V_{GSop}	Recommended Operation Value		-5...-3 / +18	V
I_D	Drain Current	Continuous ($T_C = 25^{\circ}C$)	57	A
		Continuous ($T_C = 100^{\circ}C$)	40	
I_{DM}	Drain Current	Pulsed (Note1)	142	A
P_D	Power Dissipation	($T_C = 25^{\circ}C$)	288	W
		Derate Above $25^{\circ}C$	1.9	W/ $^{\circ}C$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to 175	$^{\circ}C$
T_L	Maximum Lead Temperature for Soldering, 1/8" from Case for 10 Seconds		260	$^{\circ}C$

热特性

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.52	$^{\circ}C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

封装标识和订购信息

Part Number	Top Marking	Package	Packing Method	Quantity
PCZ120N40M2	PCZ120N40M2	TO-247-4L	Tube	30 units

电特性 (T_C = 25°C 除非另有说明)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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Off Characteristics

BV _{DSS}	Drain to Source Breakdown Voltage	V _{GS} = 0 V, I _D = 1 mA	1200			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 1200 V, V _{GS} = 0 V		1	100	μA
		V _{DS} = 1200 V, V _{GS} = 0 V, T _J = 175°C		10		
I _{GSS}	Gate-Source Leakage Current	V _{GS} = +22 V, V _{DS} = 0 V			+100	nA
		V _{GS} = -10 V, V _{DS} = 0 V			-100	

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	V _{GS} = V _{DS} , I _D = 10 mA (tested after V _{GS} = 22 V, 1 ms pulse)	2.0	3.0	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 18 V, I _D = 28 A		40.0	56.0	mΩ
		V _{GS} = 18 V, I _D = 28 A, T _J = 175°C		64.0		
		V _{GS} = 15 V, I _D = 28 A		55.5		
g _{fs}	Transconductance	V _{DS} = 20 V, I _D = 28 A		16.9		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 800 V, V _{GS} = 0 V, f = 250 kHz		1668		pF
C _{oss}	Output Capacitance			105		
C _{rss}	Reverse Capacitance			4		
E _{oss}	Stored Energy in Output Capacitance	V _{DS} = 0 V to 800 V, V _{GS} = 0 V		42		μJ
C _{o(er)}	Energy Related Output Capacitance			132		pF
C _{o(tr)}	Time Related Output Capacitance			201		
Q _{g(tot)}	Total Gate Charge	V _{DS} = 800 V, I _D = 28 A, V _{GS} = -3 V / 18 V, Inductive load		62		nC
Q _{gs}	Gate to Source Charge			20		
Q _{gd}	Gate to Drain “Miller” Charge			14		
R _G	Internal Gate Resistance	f = 1 MHz, V _{AC} = 30 mV		3.0		Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time	V _{DS} = 800 V, I _D = 28 A, V _{GS} = -3 V / 18 V, R _G = 6.8 Ω, FWD : PCH120S20D1, Inductive load		19		ns
t _r	Turn-On Rise Time			15		
t _{d(off)}	Turn-Off Delay Time			35		
t _f	Turn-Off Fall Time			8		
E _{on}	Turn-on Switching Energy			158		μJ
E _{off}	Turn-off Switching Energy			100		
E _{tot}	Total Switching Energy			258		

Electrical Characteristics (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Source-Drain Diode Characteristics						
I _S	Continuous Diode Forward Current	V _{GS} = -3 V			57	A
I _{SM}	Pulsed Diode Forward Current	V _{GS} = -3 V (Note1)			142	
V _{SD}	Diode Forward Voltage	V _{GS} = -3 V, I _{SD} = 28 A		4.3		V
t _{rr}	Reverse Recovery Time	V _{DD} = 800 V, I _{SD} = 28 A, dI _F /dt = 3000 A/μs, Includes Q _{oss}		15		ns
Q _{rr}	Reverse Recovery Charge			219		nC
I _{rm}	Peak Reverse Recovery Current			24		A

※注1：受最高结温限制

典型性能特性

Figure 1. 输出曲线 $T_J = -40^{\circ}\text{C}$

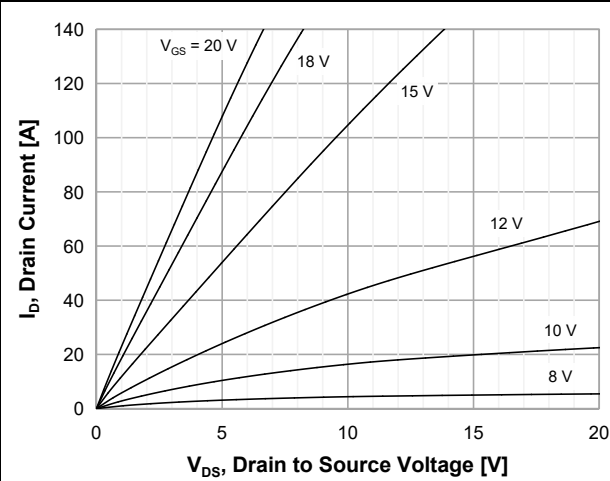


Figure 2. 输出曲线 $T_J = 25^{\circ}\text{C}$

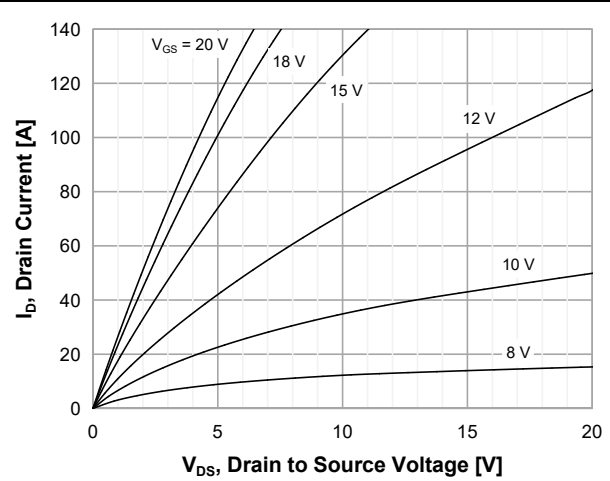


Figure 3. 输出曲线 $T_J = 175^{\circ}\text{C}$

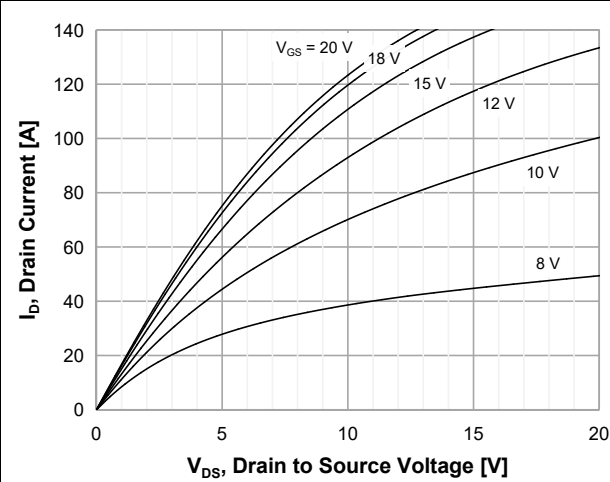


Figure 4. 规范化导通电阻特性与温度的关系

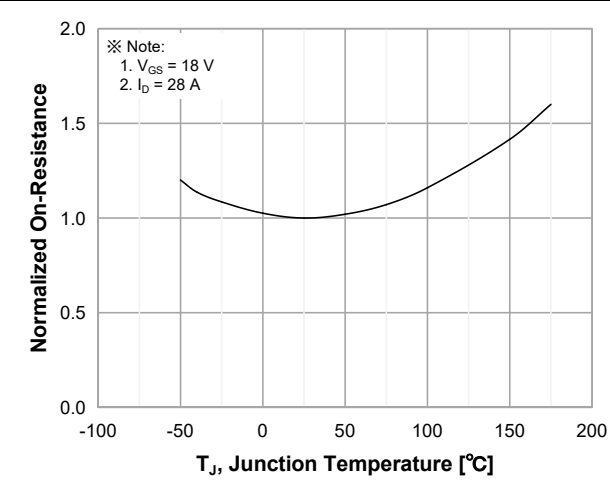


Figure 5. 传输特性曲线

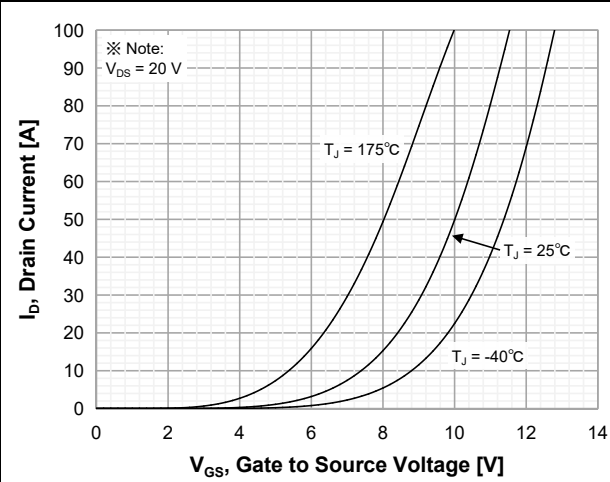
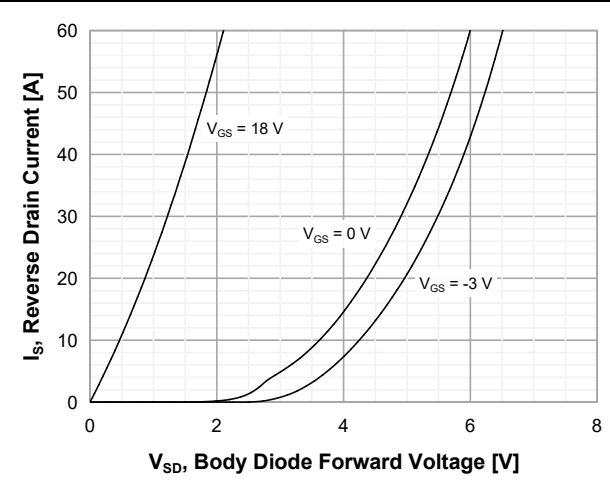
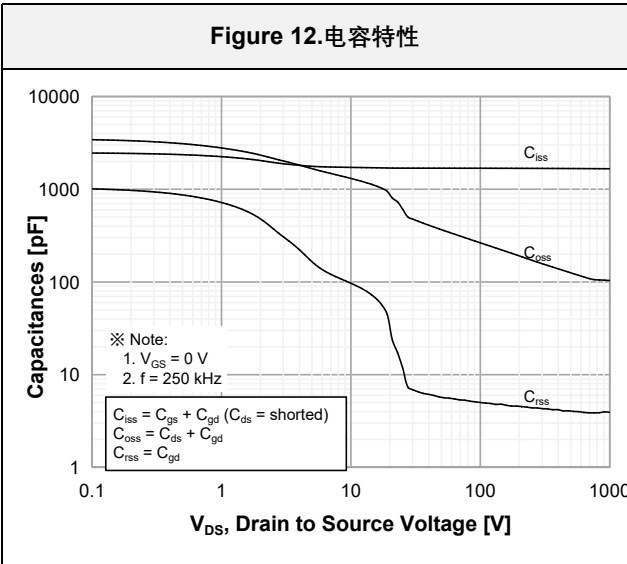
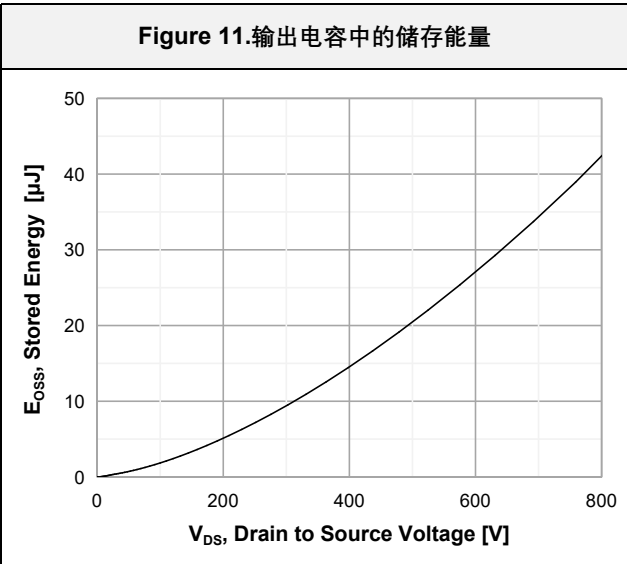
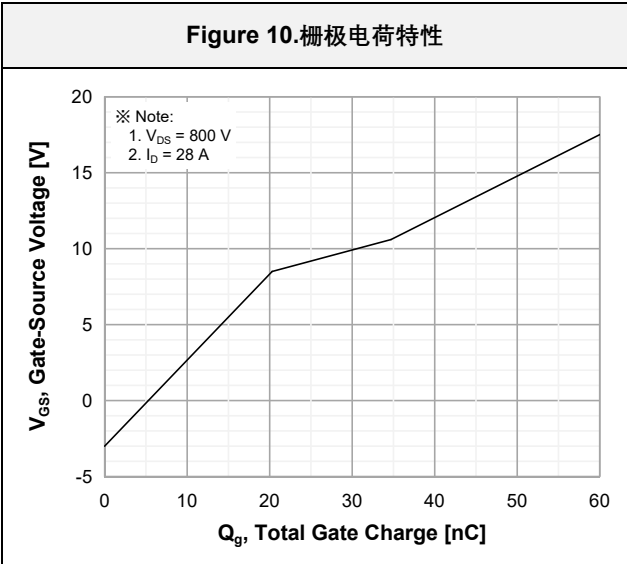
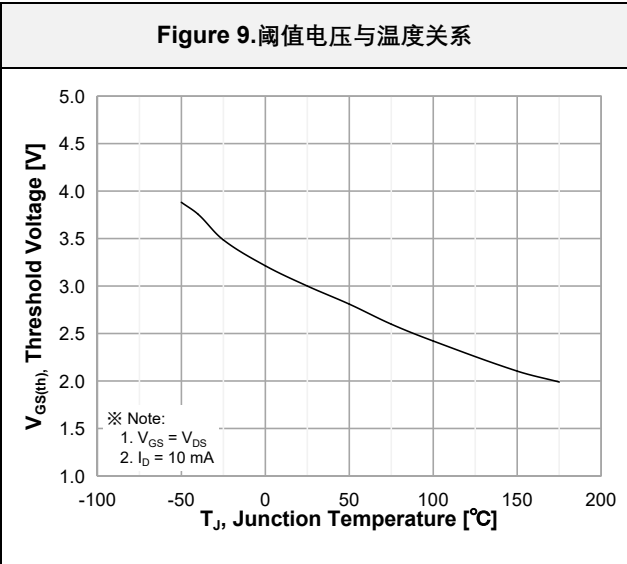
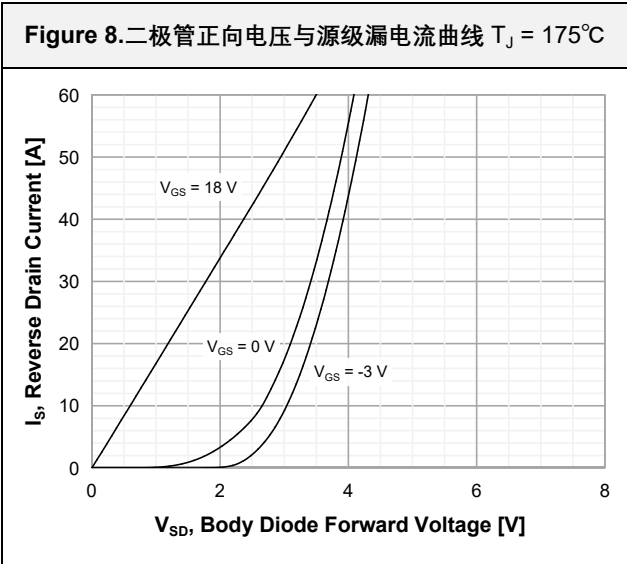
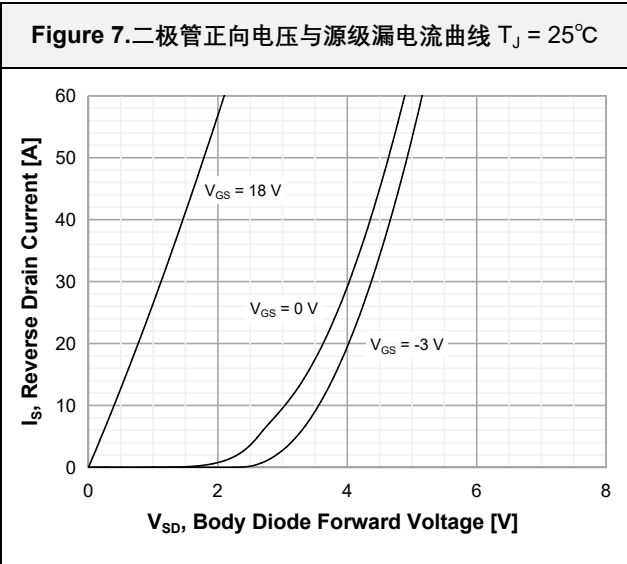


Figure 6. 二极管正向电压与源级漏电流曲线 $T_J = -40^{\circ}\text{C}$



典型性能特性



典型性能特性

Figure 13.连续漏极电流降额与外壳温度

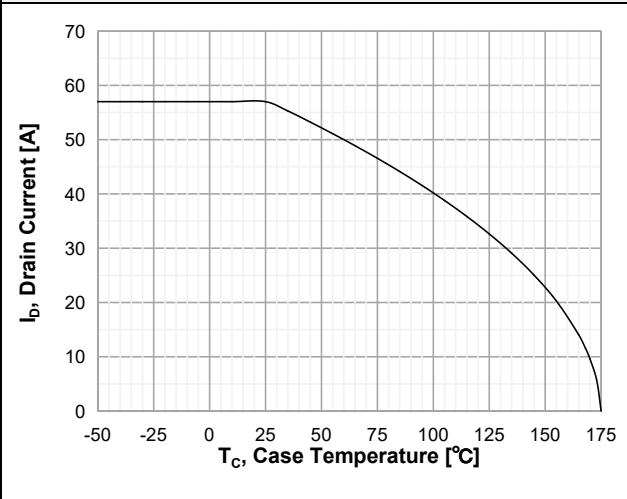


Figure 14.最大功耗降额与外壳温度

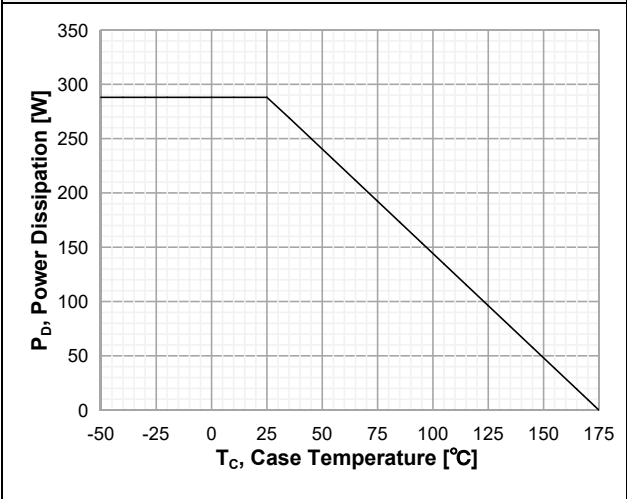


Figure 15. Typ.开关损耗与漏极电流

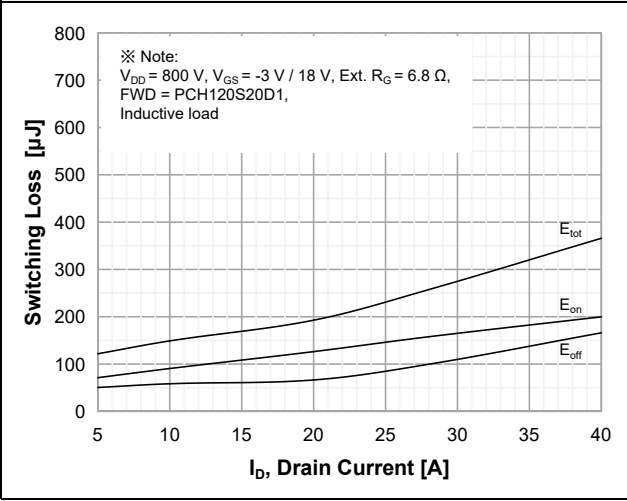


Figure 16. Typ.开关损耗与栅极电阻

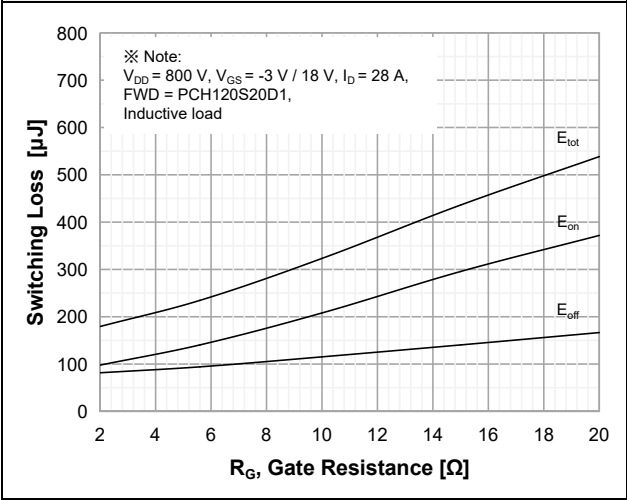


Figure 17. Typ.开关损耗与漏极电流

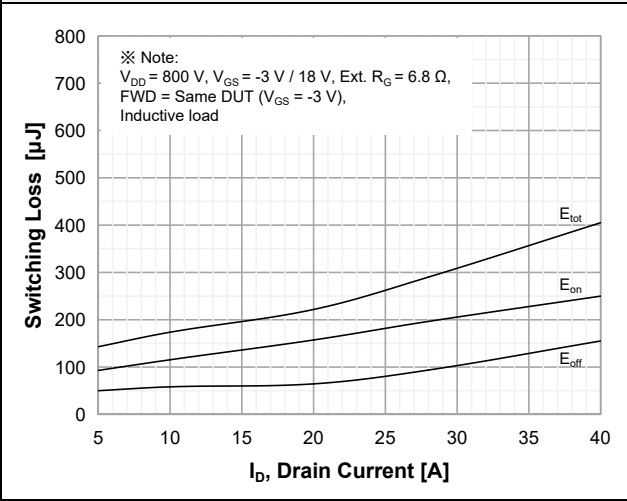
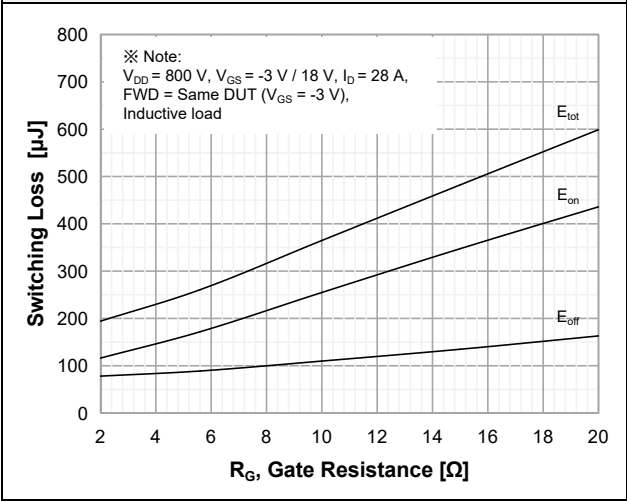


Figure 18. Typ.开关损耗与栅极电阻



典型性能特性

Figure 19.最大安全操作区域

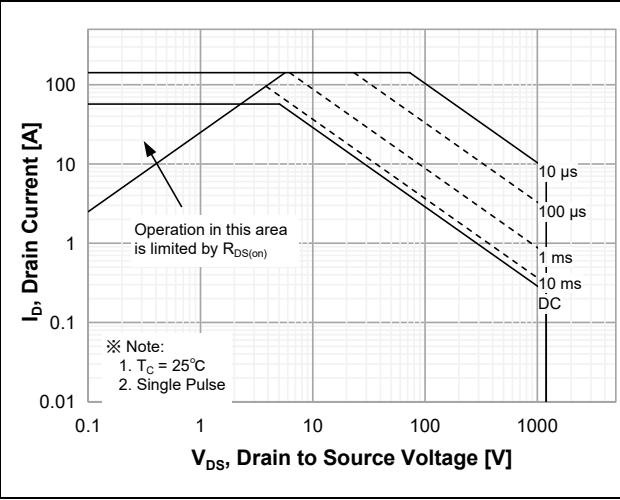


Figure 20.瞬态热响应曲线

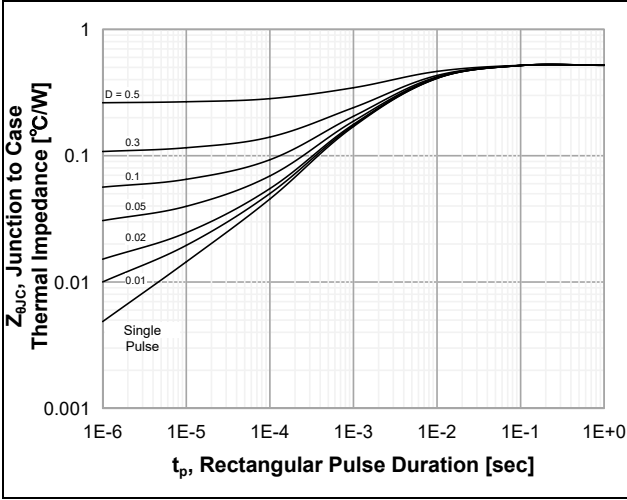


Figure 21.电感负载切换测试电路和波形

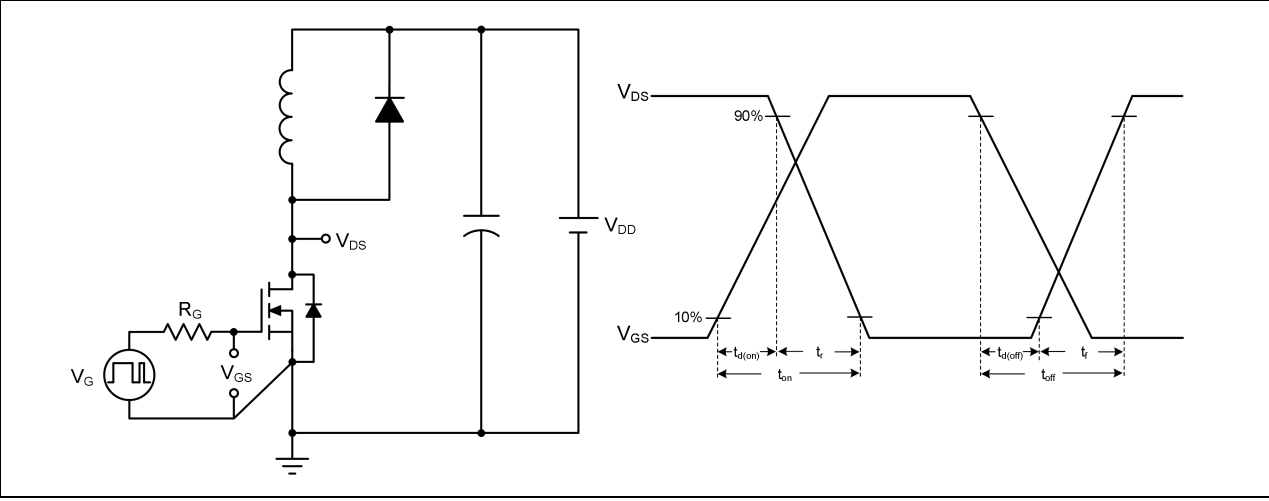
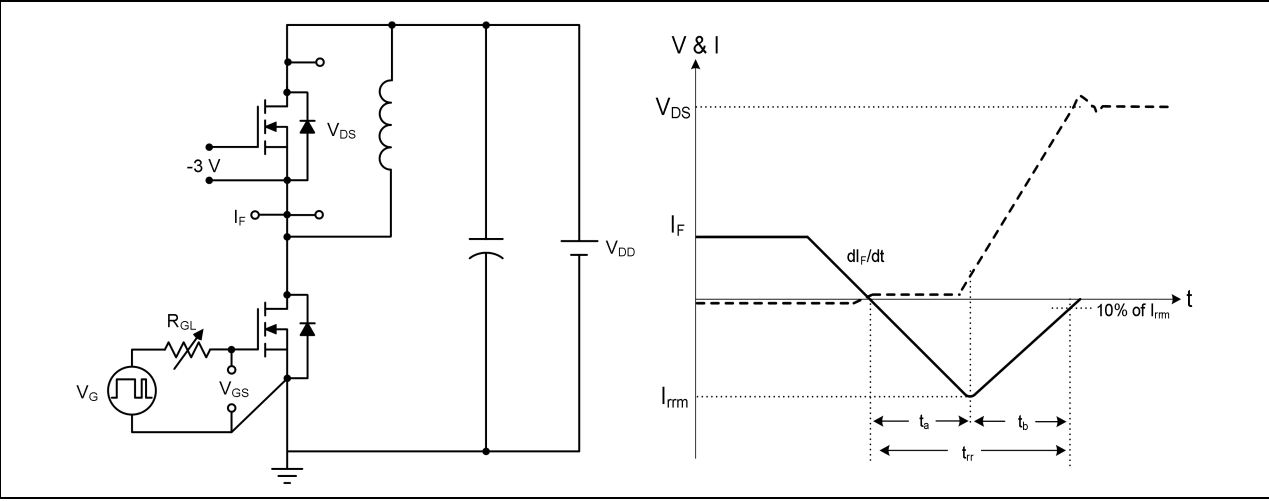
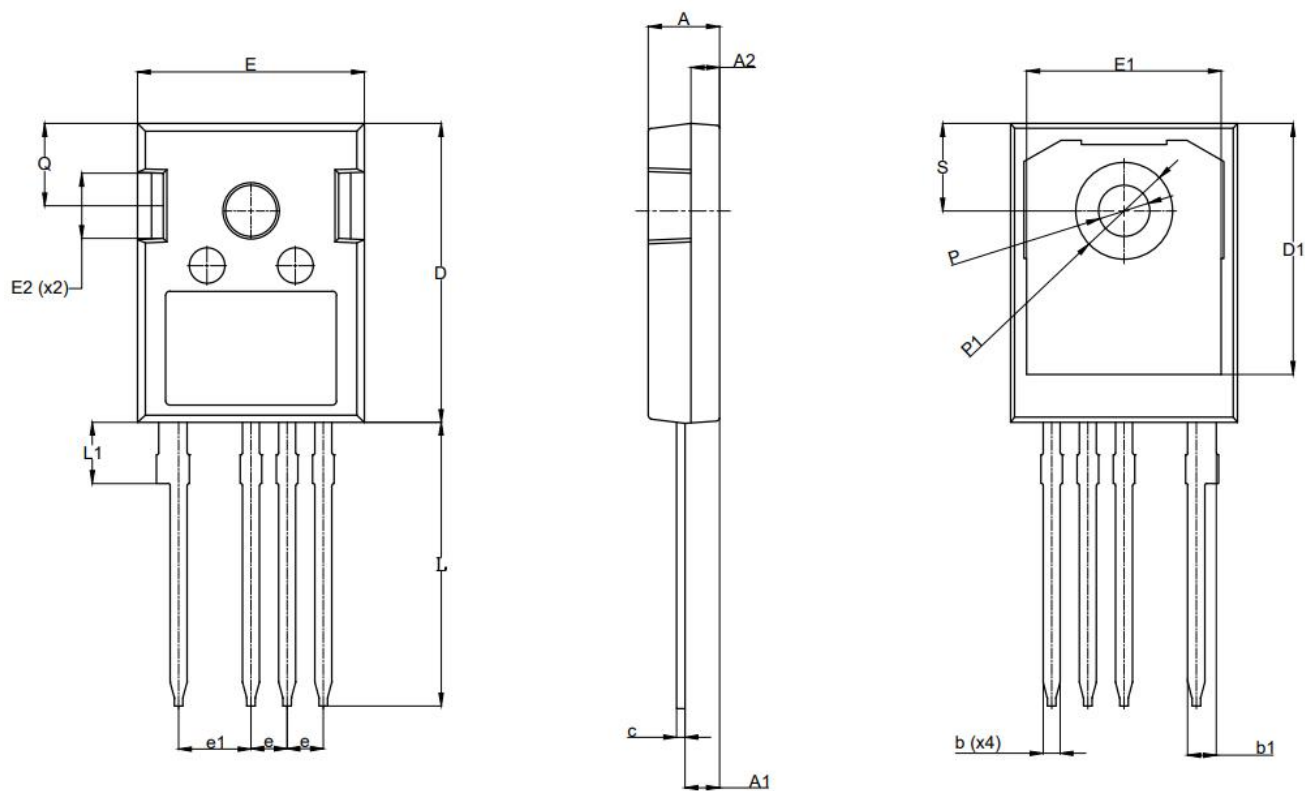


Figure 22.峰值二极管恢复dv/dt测试电路和波形



Package Outlines

TO-247-4L



SYMBOL	Common		
	DIMENSIONS MILLIMETER		
	MIN.	NOM.	MAX.
A	4.80	5.00	5.20
A1	2.29	2.42	2.54
A2	1.90	2.00	2.10
b	1.10	1.20	1.30
b1	1.86	2.01	2.15
c	0.50	0.60	0.70
D	20.90	21.00	21.10
D1	17.43	17.63	17.83
E	15.75	15.94	16.13
E1	13.46	13.66	13.86
E2	4.32	4.58	4.83
e	2.54 BSC.		
e1	5.08 BSC.		
L	19.80	19.95	20.10
L1	-	-	4.30
P	3.56	3.61	3.66
P1	6.75	6.80	6.85
Q	5.38	5.79	6.20
S	6.15 BSC.		

* Dimensions in millimeters